07/15/2013 502418614

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
TAIWAN IC PACKAGING CORPORATION	07/12/2013	

RECEIVING PARTY DATA

Name:	TAIWAN IC PACKAGING CORPORATION	
Street Address:	NO.2, SOUTH 3RD ROAD, K.E.P.Z.	
City:	Kaohsiung	
State/Country:	te/Country: TAIWAN	

Name:	uPI semiconductor corp.		
Street Address:	9F1, No.5, Taiyuan 1st St., Zhubei City		
City:	Hsinchu County		
State/Country:	TAIWAN		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13769634

CORRESPONDENCE DATA

Fax Number: 7039974517

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

3027291562 Phone:

Email: Patent.admin.uspto.cr@naipo.com

Correspondent Name: WINSTON HSU Address Line 1: P.O.BOX 506

Address Line 4: Merrifield, VIRGINIA 22116

ATTORNEY DOCKET NUMBER:	TICP0002USA
NAME OF SUBMITTER:	JANINE CHANG

REEL: 030792 FRAME: 0475

PATENT

Signature:	/JANINE CHANG/
Date:	07/15/2013
Total Attachments: 2 source=1697780#page1.tif source=1697780#page2.tif	

PATENT REEL: 030792 FRAME: 0476



Form of Recordable Patent Assignment and Reservation

Form of Recordable Patent Assignment and Reservation

WHEREAS, in consideration of One Dollar(\$1.00) and other goods and valuable considerations, the receipt of which is hereby acknowledged, and subject to the reservations stated in the Patent Assignment Agreement between parties,

TAIWAN IC PACKAGING CORPORATION, a corporation organized and existing under the laws of TAIWAN,

(hereinafter "ASSIGNOR(S)")

HEREBY grant(s) and assign(s) to

TAIWAN IC PACKAGING CORPORATION, a corporation organized and existing under the laws of TAIWAN,

UPI SEMICONDUCTOR CORP., a corporation organized and existing under the laws of TAIWAN,

(hereinafter "ASSIGNEE(S)")

all of the ASSIGNOR(S)'s rights, title and interest in and to the United States Letters Patent(s) and patent application(s) identified in Exhibit A attached hereto, (hereinafter, collectively, "ASSIGNED PATENT(S)"), to have and to hold the same, unto ASSIGNEE(S) for his/their own use and enjoyment and for the use and enjoyment of his/their successors and assigns, including all damages for infringement of any of the ASSIGNED PATENT(S) and the sole right to sue therefore under such ASSIGNED PATENT(S), for the full term(s) of all such ASSIGNED PATENT(S), subject to all rights granted under the ASSIGNED PATENT(S) to third parties by ASSIGNOR(S) prior to the effective date of the said

ASSIGNOR(S) hereby reserve(s) and retain(s), for the benefit of himself/themselves and his/their subsidiaries and their successors and assigns, the rights and licenses set forth in the Patent Assignment Agreement.

TAIWAN IC PACKAGING CORPORATION
(Assigner)

Signature: Chih-Song Chen

Name: Chih-Song Chen

Title: General Manager

Date: 17/(2 '(3

TAIWAN IC PACKAGING CORPORATION
(Assignee)

Signature: Chih-Song Chen

Name: Chih-Song Chen

Title: General Manager

Date: 1/12 /13

UPI SEMICONDUCTOR CORP. (Assignee)

Signature: Tien - Chin Clary

Name: Tien-Chin Chang

Title: President

Date: JUL 0 4 2013

1 / 2

F#NPO-P0002E-US3 DSB0-102U015266

Exhibit A

United States Patent Application(s)

Serial No.	Application No.	Filing Date	Assignor		Assignee	
			Name	Interest(%)	Name	Interest(%)
1	13/769,634	2013/02/18	TAIWAN IC PACKAGING CORPORATIO N	100%	TAIWAN IC PACKAGING CORPORATION	50%
					UPI SEMICONDUCT OR CORP.	50%

End of Exhibit A

2 / 2

F#NPO-P0002E-US3 DSB0-102U015266

PATENT REEL: 030792 FRAME: 0478